TELEFUNKEN Semiconductors

AM Receiver Circuit

Technology: Bipolar

Features

- Controlled RF preamplifier
- Multiplicative balanced mixer
- Separate oscillator with amplitude control
- IF amplifier with gain control

- Balanced full-wave detector
- Audio preamplifier
- Internal AGC voltage
- Amplifier for field-strength indication
- Electronic stand-by on/off switch

Case: 16 pin dual inline plastic

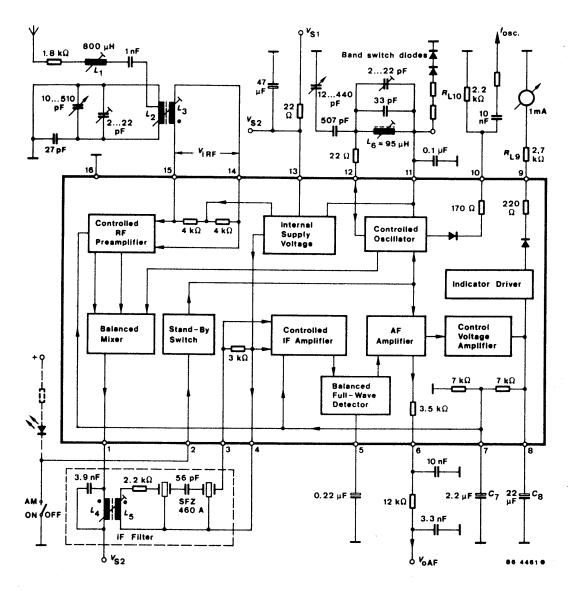


Figure 1 Block diagram and application circuit

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Absolute maximum ratings

Reference point pin 16, unless otherwise specified

Parameters		Symbol	Value	Unit
Supply voltage	Pin 13	V _S	20	V
Voltage on Pin 2		V ₂	0 to 20	V
RF inputs Voltages				
Reference point 15	Pin 14	$\pm V_{i \ 14/15}$	12	V
	Pin 14	V_i	$V_{\rm s}$	V
	Pin 14	$-V_i$	0.6	V
	Pin 15	V _i	V_{i}	V
	Pin 15	$-V_i$	0.6	V
RF inputs				
Currents	Pin 14, 15	$\pm I_i$	200	mA
Ambient temperature range		T _{amb}	-30 to + 80	°C
Storage temperature range		T _{stg}	-55 to + 150	°C

Electrical Characteristics

 $V_S = 8.5$ V, reference point pin 16, $f_{IRF} = 1$ MHz, $R_G = 50$ Ω , $f_{mod} = 0.4$ kHz, m = 30%, $f_{IF} = 460$ kHz, $T_{amb} = +25$ °C, unless otherwise specified

Parameters	Test Conditions	/ Pin	Symbol	Min	Type	Max	Unit
Supply voltage range	Pi	in 13	V_{S}	7.5	18		V
Supply current, without load, $I_L = 0$ (Pin 11)	Pi	in 13	I _S		23	30	mA
RF preamplifier and mixer							
DC input voltages	Pi	in 14, 15	Vi		V _S /2		V
Input impedances	V_{iRF} < 300 μ V, Pi V_{iRF} > 10 mV, Pi	in 14,15 in 14, 15	R _i C _i R _i C _i		5.5 25 8.0 22		kΩ pF kΩ pF
Output impedance	Pin 1		R _o C _o	500	6.0		kΩ pF
Maximum conversion conductance	I _{o 1 IF} /V _{iRF}		$\Delta S_{ m M}$			6.5	mA/V
Maximum IF output voltage	Pi	in 1	$V_{ m oIF}$			5.0	V _{pp}
Output current	Pi	in 1	Io		1.2		mA
Preamplifier control range			$S_{\mathbf{M}}$		30		dB
Max. RF input voltage	Pi	in 14, 15	Vi			2.5	V _{pp}
Oscillator							
Frequency range	Pi	in 12	f_{OSC}	0.6		60	MHz
Oscillator circuit impedance range	Pi	in 12	Z_{LOSC}	0.5		200	kΩ

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Parameters	Test Conditions / Pin	Symbol	Min	Type	Max	Unit
Controlled oscillator amplitude	Pin 12	V _{OSC}		130	150	mV
DC output voltage	$I_L = 0 \text{ V}$ Pin 11	Vo		6 V _{BE(4V)}		V
Output load current range	Pin 11	$-I_{L}$			20	mA
Output resistance	$I_L = 5 \pm 0.5 \text{ mA}, \text{ Pin } 11$	RO		25		Ω
Oscillator frequency outpu	t Pin 10					
Output voltage	$R_{L10} = 4.7 \text{ k}\Omega$	V_0		320		mV _{pp}
Output resistance		R_0		170		Ω
Allowable output current		I_0			3	mAp
IF amplifier an AF stage						
DC input voltages	Pin 3, 4	Vi		2		V
Input impedance	Pin 3	R _i C _i	2.4	3 7	3.9	kΩ pF
Max. IF input voltage	m = 80%, d = 3% Pin 3	Vi		90		mV
Control range	$V_{0AF} = -6 \text{ dB}$	ΔV_i	61			dB
Audio output voltage	Pin 6 V _i = 1 mV (Pin 3), without load	V_0		310		mV
Audio output resistance	Pin 6	R ₀		3.5		kΩ
Field-strength indication		•				
DC indicator voltages	$\label{eq:RL9} \left \begin{array}{ll} R_{L9} = 2.7 \text{ k}\Omega, \\ V_i = 0 & \text{Pin 9} \\ V_i = 500 \text{ mV} & \text{Pin 9} \end{array} \right $	$egin{array}{c} V_{\mathrm{O}} \ V_{\mathrm{O}} \end{array}$	0 2.5	2.8	140 3.1	mV V
Output current capability	Pin 9	-I _O	2.0			mA
Output resistance	$-I_0 = 0.5 \text{ mA}$ Pin 9	R_0		220		Ω
Reverse voltage at the output	AM switch-Off, $\pm I_0 \le 1 \mu A$	V_0		6		V
Stand-by switch						
Switching voltage	Pin 2	Vi		2.75		V
Required control voltage	AM ON Pin 2 AM OFF Pin 2	V_i $V_i^{(1)}$	3.5		2	V V
Input current	AM on, switching current AM off, reverse current $(V_2 = V_3)$, Pin 2	$-I_{i} \\ \pm I_{i}$			200 10	μΑ μΑ

¹⁾ or open input

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Operating conditions

 $V_S = 8.5 \text{ V}, f_{iRF} = 1 \text{MHz}, f_{mod} = 0.4 \text{ kHz}, m = 30\%, T_{amb} = 25^{\circ}\text{C}, reference point Pin 16, see figure 2, unless otherwise specified$

Parameters	Test Conditions / Pin	Symbol	Min	Type	Max	Unit
RF input voltages	(S + N)/N = 6 dB = 26 dB = 46 dB	$egin{array}{c} V_{iRF} \ V_{iRF} \ \end{array}$		1.5 15 150		μV μV μV
RF input for agc operation		V _{iRF}		30		μV
Control range for	$ \begin{aligned} &(Reference\ value \\ &V_i = 500\ mV) \\ &\Delta V_0 = 6\ dB \\ &\Delta V_0 = 1\ dB \end{aligned} $	$\Delta m V_{iRF} \ \Delta m V_{iRF}$		91 86		dB dB
Maximum RF input voltage	d = 3%, m = 80% d = 3%, m = 30% d = 10%, m = 30%	V _{iRF} V _{iRF} V _{iRF}		0.5 0.7 0.9		V V V
Audio output voltage	$V_1 = 1 \text{ mV} $ $V_2 = 4 \mu\text{V}, m = 0.8$	$egin{array}{c} V_{0AF} \ V_{0AF} \end{array}$			2 dB) 3.5 dB)	mV mV
RF input voltage	$V_{0AF} = 60 \text{ mV}$	V _{iRF}		5.5		μV
Total distortion of audio output voltage	$\label{eq:controller} \left \begin{array}{ll} m=80\%, & V_i=1\ mV \\ V_i=500\ mV \end{array} \right $	d d		0.5 3.0		% %
Signal plus noise to noise ratio of audio output voltage	$V_i = 1 \text{ mV}$	$\frac{(S+N)}{N}$		50		dB
IF bandwidth (–3 dB)		B _{iF}		4.6		kHz
IF selectively	$\Delta f = \pm 9 \text{ kHz}$ $\Delta f = \pm 36 \text{ kHz}$	S _{iF} S _{iF}		30 60		dB dB

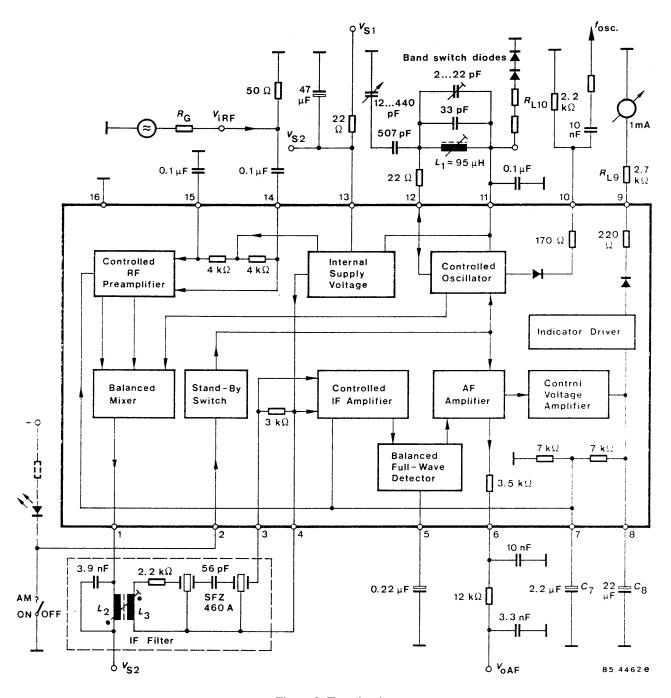
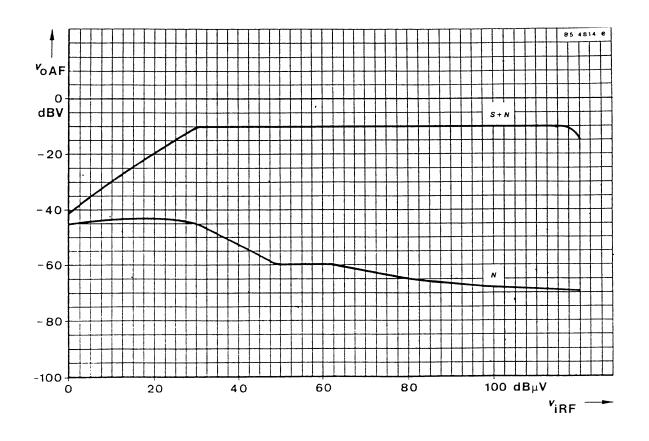
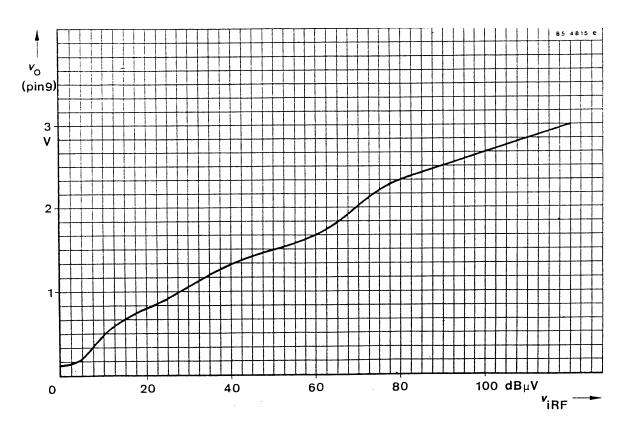
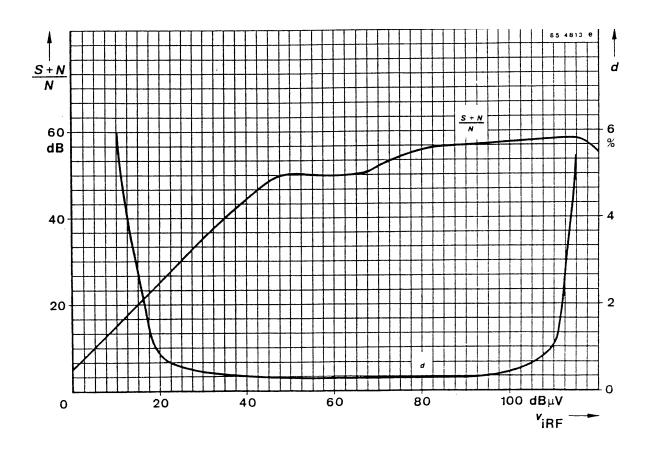


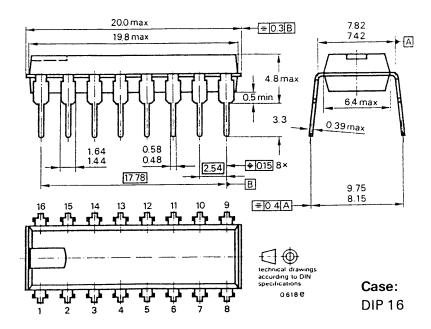
Figure 2 Test circuit







Dimensions in mm



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OZONE DEPLETING SUBSTANCES POLICY STATEMENT

It is the policy of TEMIC TELEFUNKEN microelectronic GmbH to

- 1. Meet all present and future national and international statutory requirements and
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

Of particular concern is the control or elimination of releases into the atmosphere of those substances which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) will soon severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of any ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA and
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with and do not contain ozone depleting substances.

We reserve the right to make changes to improve technical design without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use TEMIC products for any unintended or unauthorized application, the buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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